DATA	1	SHEET			
	X	SHELI			
		102CWDT	TINA		
PART NO.: I	L-C	192CWD1-	-HIVI		
DE	7 1/•	B/2			
KL	٧.	<u>D/ Z</u>			
CUSTOMER'S APPROVAL :		DATE 2021 11 2	DCC:		1
DRAWING NO. : DS-75-14-0003		DATE : 2021-11-2	zu Pa	age	1 LD-R/R005

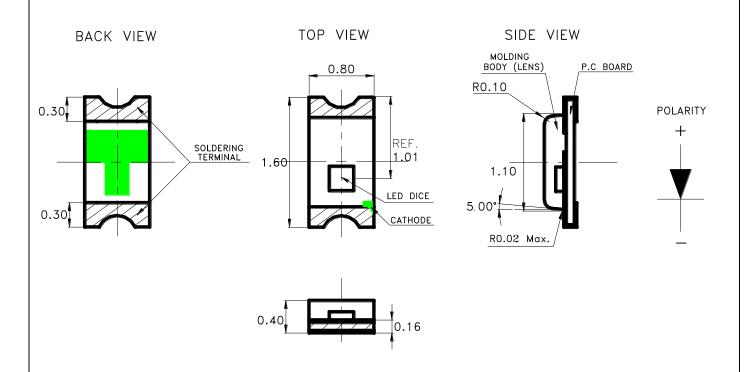
Part No.: L-C192CWDT-HM

REV: B/2

Features

- * Extra thin 0.4mm, Top view, Wide view angle, White color SMD chip LED.
- * Special for Cellular Phone keypad / LCD backlighting or thin touch button LED backlighting.
- * Packing in 8mm tape on 7" diameter reels.
- * Compatible with automatic Pick & Place equipment.
- * Compatible with Reflow soldering and Wave soldering processes.
- * EIA STD package.(ANSI/EIA-481-B-2001)
- * I.C. compatible, low current application
- * Pb free product and acceptable lead-free process!.
- * Meet RoHS Green Product.
- * Moisture sensitivity level: 3

PACKAGE OUTLINE DIMENSIONS



Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.1mm (.004") unless otherwise noted.

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REV: B/2

Part No.: L-C192CWDT-HM

CHIP MATERIALS

Dice Material : InGaNLight Color : White

* Lens Color : Yellow Diffused.

Absolute Maximum Ratings(Ta=25°C)

Symbol	Parameter	Rating	Unit
PD	Power Dissipation	76	mW
IPF	Peak Forward Current	80	mA
11 1	(1/10 Duty Cycle, 0.1ms Pulse Width)	80	
IF	Continuous Forward Current	2	mA
VR	Reverse Voltage	5	V
ESD	Electrostatic Discharge Threshold(HBM)Note A	1000	V
Topr	Operating Temperature Range	-30 ~ + 80	$^{\circ}\!\mathbb{C}$
Tstg	Storage Temperature Range	-40 ~ + 85	$^{\circ}\!\mathbb{C}$

Note A:

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

• Electro-Optical Characteristics(Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition	
Luminous Intensity	IV	112	130	180	mcd	IF=5mA	
Viewing Angle	2 θ 1/2		130		Deg	Note 2	
CIE Chromaticity	X		0.30			IF=5mA	
CIE Chromaticity	Y		0.27				
Forward Voltage	VF	2.7	2.9	3.1	V	IF =5mA	
Reverse Current	IR			50	μА	VR = 5V	

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REV: B/2

Part No.: L-C192CWDT-HM

Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Caution in ESD:
 - Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 4. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

Typical Electro-Optical Characteristics Curves

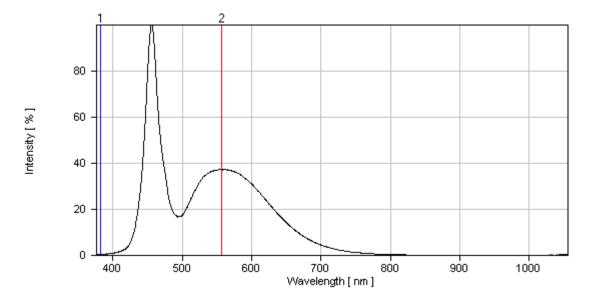


Fig.1 Relative Intensity vs. Wavelength

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Part No.: L-C192CWDT-HM

Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

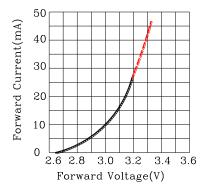


Fig.2 Forward Current vs.Forward Voltage

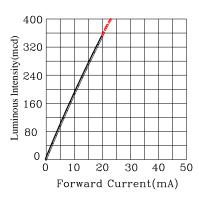


Fig.3 Luminous Intensity vs.Forward Current

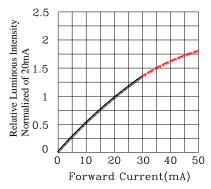


Fig.4 Relative Luminous Intensity vs.Forward Current

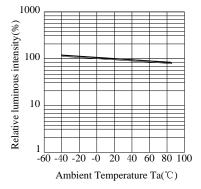


Fig.5 Luminous Intensity vs.Ambient Temperature

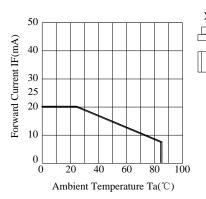


Fig.6 Forward Current Derating Curve

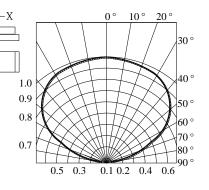
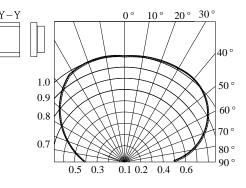


Fig.7 Relative Intensity vs.Angle



REV: B/2

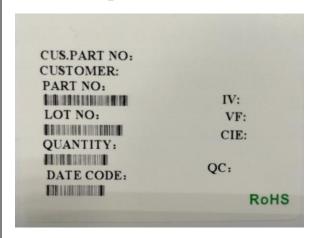
Fig.7 Relative Intensity vs.Angle

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Part No.: L-C192CWDT-HM

REV: B/2

Label Explanation



ITEM CODE:PARA LIGHT

PART NO: L-C192CWDT-HM

IV --- Luminous Intensity Code

LOT NO: EM S L 12 09 0110 A B C D E F

A---EM: Emos Code

B---S:SMD

L---Local

D---Year

E---Month

F---SPEC.

PACKING QUANTITY OF BAG:

3000pcs for 150, 170, 110, 155, 115 series

4000pcs for 191 series

5000pcs for 192 series

DATE CODE: 2012 09 10

G H I

G--- Year

H--- Month

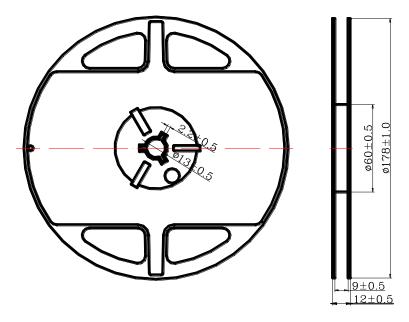
I --- Day

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REV: B/2

Part No.: L-C192CWDT-HM

Reel Dimensions



Notes:

1. Taping Quantity: 4000pcs

2. The tolerances unless mentioned is ± 0.1 mm, Angle $\pm 0.5^{\circ}$, Unit: mm.

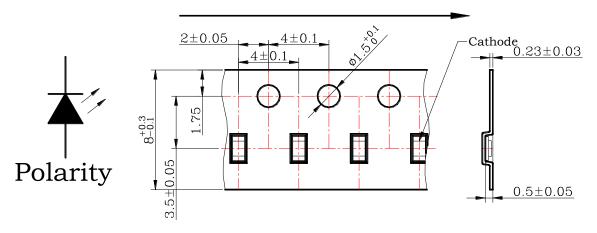
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Part No.: L-C192CWDT-HM

Package Dimensions Of Tape And Reel

Progressive direction

REV: B/2



Notes: All dimensions are in millimeters.

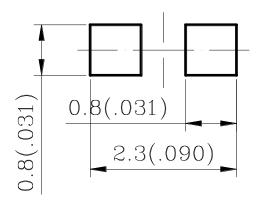
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Part No.: L-C192CWDT-HM

Cleaning

- * If cleaning is required, use the following solutions for less than 1 minute and less than 40°C.
- * Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- * Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

Suggest Soldering Pad Dimensions





REV: B/2

Direction of PWB camber and go to reflow furnace

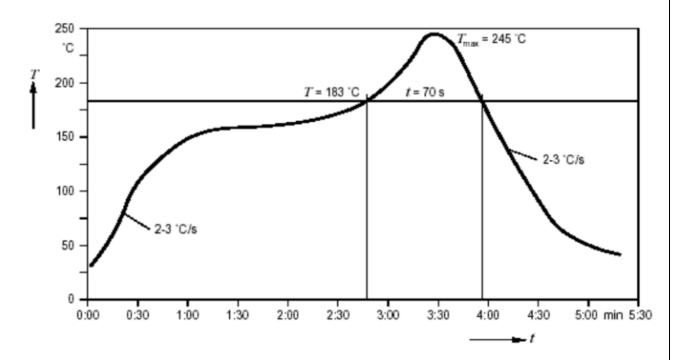
Notes: Suggest stencil print screen thickness are 0.10mm maximum.

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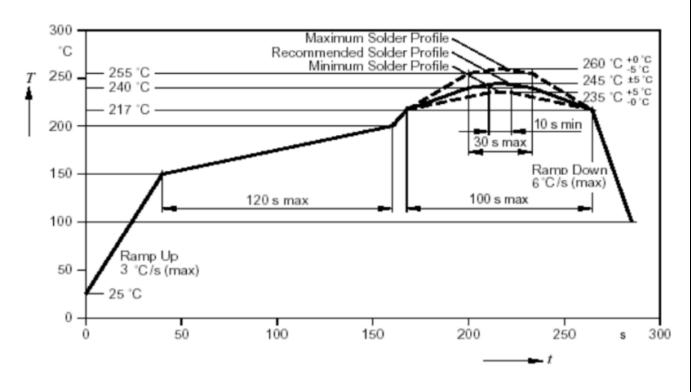
Part No.: L-C192CWDT-HM

REV: B/2

• Suggest Sn/Pb IR Reflow Soldering Profile Condition:



• Suggest Pb-Free IR Reflow Soldering Profile Condition:



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Part No.: L-C192CWDT-HM

Bin Code List

Luminous Inte	ensity(IV), Un	-	Forward	
Bin Code	Min	Max		Bin Cod
R1	112	140		12
R2	140	180		13
				14
				15

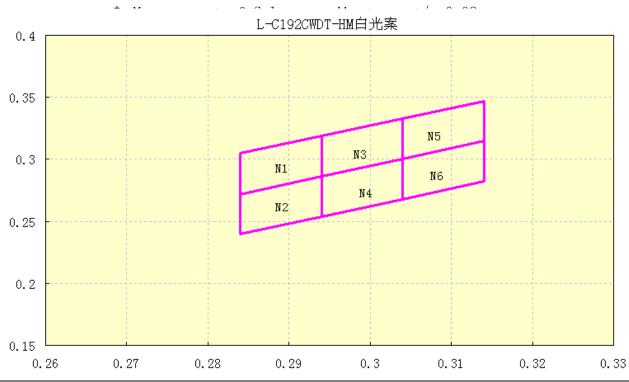
Forward Voltage(VF), Unit:V@5mA						
Bin Code	Min	Max				
12	2.7	2.8				
13	2.8	2.9				
14	2.9	3.0				
15	3.0	3.1				

REV: B/2

Tolerance of each bin are $\pm 15\%$

Tolerance of each bin are ± 0.1 Volt

	Color Rank (CIE chromaticity X, Y) @ 5mA								
	Rank N1				Rank N2				
X	0.284	0.284	0.294	0.294	X	0.284	0.284	0.294	0.294
Y	0.2715	0.305	0.319	0.286	Y	0.24	0.2715	0.286	0.254
	Rank N3				Rank N4				
X	0.294	0.294	0.304	0.304	X	0.294	0.294	0.304	0.304
Y	0.286	0.319	0.333	0.3005	Y	0.254	0.286	0.3005	0.268
Rank N5				Rank N6					
X	0.304	0.304	0.314	0.314	X	0.304	0.304	0.314	0.314
Y	0.3005	0.333	0.347	0.315	Y	0.268	0.3005	0.315	0.282



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REV: B/2

Part No.: L-C192CWDT-HM

CAUTIONS

1. Application Limitation:

The LED's described here are intended to be used for ordinary electronic equipment(such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage:

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150 ℃, 120sec. MAX., Peak temperature : 240 ℃ Max. Soldering time : 10 sec Max.

Soldering Iron: (Not recommended)

Temperature 300 °C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering. Wave soldering :

Pre-heat 100 °C Max, Pre-heat time 60 sec. Max, Solder wave 260 °C Max, Soldering time 5 sec. Max. performed consecutively cooling process is required between 1st and 2nd soldering processes.

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REV: B/2

Part No.: L-C192CWDT-HM

4. Lead-Free Soldering

For Reflow Soldering:

- 1. Pre-Heat Temp: 150-180°C,120sec.Max.
- 2. Soldering Temp: Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3. Peak Temperature: 260°C, 5sec.
- 4. Reflow Repetition: 2 Times Max.
- 5. Suggest Solder Paste Formula: 93.3 Sn/3.1 Ag/3.1 Bi/0.5 Cu

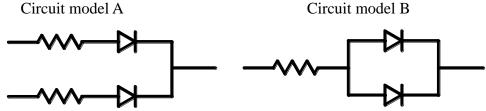
For Soldering Iron (Not Recommended):

- 1. Iron Tip Temp: 350°C Max.
- 2. Soldering Iron: 30w Max.
- 3. Soldering Time: 3 Sec. Max. One Time.

For Dip Soldering:

- 1. Pre-Heat Temp: 150°C Max. 120 Sec. Max.
- 2. Bath Temp: 265°C Max.
- 3. Dip Time: 5 Sec. Max.

5. Drive Method



- (A)Recommended circuit.
- (B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.

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